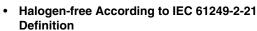


CJ2312-VB Datasheet

N-Channel 20 V (D-S) MOSFET

| PRODUC | CT SUMMARY | | | | |
|---------------------|----------------------------------|---------------------------------|-----------------------|--|--|
| V _{DS} (V) | $R_{DS(on)}\left(\Omega\right)$ | I _D (A) ^e | Q _g (Typ.) | | |
| | 0.028 at V _{GS} = 4.5 V | 6 ^a | | | |
| 20 | 0.042 at V _{GS} = 2.5 V | 6 ^a | 8.8 nC | | |
| | 0.050 at V _{GS} = 1.8 V | 5.6 | | | |

FEATURES • Halogen-free According to IEC





- 100 % R_g Tested
- Compliant to RoHS Directive 2002/95/EC



RoHS COMPLIANT HALOGEN FREE

APPLICATIONS

- DC/DC Converters
- Load Switch for Portable Applications

| | SOT-23 | | |
|------------|----------|---|---|
| G 1 S 2 | | 3 | D |
| | Top View | | |

| ABSOLUTE MAXIMUM RATIN | IGS $T_A = 25 ^{\circ}C$, | unless othe | rwise noted | | |
|--|-----------------------------|-----------------------------------|----------------------|------|--|
| Parameter | | Symbol | Limit | Unit | |
| Drain-Source Voltage | | V_{DS} | 20 | V | |
| Gate-Source Voltage | | V_{GS} | ± 12 | V | |
| | T _C = 25 °C | | 6 ^a | | |
| Continuous Drain Comment /T 150 °C\ | T _C = 70 °C | 1 | 5.1 | | |
| Continuous Drain Current (T _J = 150 °C) | T _A = 25 °C | l _D | 5 ^{b, c} | | |
| | T _A = 70 °C | | 4 ^{b, c} | A | |
| Pulsed Drain Current | | I _{DM} | 20 | | |
| Continuous Source-Drain Diode Current | T _C = 25 °C | | 1.75 | | |
| Continuous Source-Drain Diode Current | T _A = 25 °C | l _S | 1.04 ^{b, c} | | |
| | T _C = 25 °C | | 2.1 | | |
| Maximum Bayer Dissination | T _C = 70 °C | | 1.3 | w | |
| Maximum Power Dissipation | T _A = 25 °C | P _D | 1.25 ^{b, c} | vv | |
| | T _A = 70 °C | • | 0.8 ^{b, c} | | |
| perating Junction and Storage Temperature Range | | T _J , T _{stg} | - 55 to 150 | °C | |
| Soldering Recommendations (Peak Temperature) | | | 260 | | |

| THERMAL RESISTANCE RAT | INGS | | | | |
|---|--------------|-------------------|---------|---------|--------|
| Parameter | | Symbol | Typical | Maximum | Unit |
| Maximum Junction-to-Ambient ^{b, d} | t ≤ 5 s | R _{thJA} | 80 | 100 | °C/W |
| Maximum Junction-to-Foot (Drain) | Steady State | R_{thJF} | 40 | 60 | O/ V V |

Notes:

- a. Package limited
- b. Surface Mounted on 1" x 1" FR4 board.
- c. t = 5 s
- d. Maximum under steady state conditions is 125 $^{\circ}\text{C/W}.$
- e. Based on T_C = 25 °C.

服务热线:400-655-8788

1



| Parameter | Symbol | Test Conditions | Min. | Тур. | Max. | Unit |
|---|-------------------------|---|----------|----------|-------|-----------|
| Static | | | l | | | |
| Drain-Source Breakdown Voltage | V _{DS} | $V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$ | 20 | | | V |
| V _{DS} Temperature Coefficient | $\Delta V_{DS}/T_{J}$ | I _D = 250 μA | | 25 | | m\//°C |
| V _{GS(th)} Temperature Coefficient | $\Delta V_{GS(th)}/T_J$ | I _D = 250 μA | | - 2.6 | | mV/°0 |
| Gate-Source Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}$, $I_{D} = 250 \mu A$ | 0.45 | | 1.0 | V |
| Gate-Source Leakage | I _{GSS} | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$ | | | ± 100 | nA |
| | | $V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}$ | | | 1 | |
| Zero Gate Voltage Drain Current | IDSS | V _{DS} = 20 V, V _{GS} = 0 V, T _J = 70 °C | | | 10 | μΑ |
| On-State Drain Current ^a | I _{D(on)} | $V_{DS} \le 5 \text{ V}, V_{GS} = 4.5 \text{ V}$ | 20 | | | Α |
| | , , | $V_{GS} = 4.5 \text{ V}, I_D = 5.0 \text{ A}$ | | 0.028 | | |
| Drain-Source On-State Resistance ^a | R _{DS(on)} | $V_{GS} = 2.5 \text{ V}, I_D = 4.7 \text{ A}$ | | 0.042 | | Ω |
| | \ \ \ \ \ | $V_{GS} = 1.8 \text{ V}, I_D = 4.3 \text{ A}$ | | 0.050 | | |
| Forward Transconductance ^a | 9 _{fs} | V _{DS} = 10 V, I _D = 5.0 A | | 24 | | S |
| Dynamic ^b | 1 | | | L | | <u>,L</u> |
| Input Capacitance | C _{iss} | | | 865 | | |
| Output Capacitance | C _{oss} | $V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$ | | 105 | | ρF |
| Reverse Transfer Capacitance | C _{rss} | De la de | | 55 | | - |
| · · | | V _{DS} = 10 V, V _{GS} = 5 V, I _D = 5.0 A | | 12 | 18 | |
| Total Gate Charge | Qg | 50 / GO / D | | 8.8 | 14 | pF nC |
| Gate-Source Charge | Q _{gs} | $V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 5.0 \text{ A}$ | | 1.1 | | nC |
| Gate-Drain Charge | Q _{gd} | 23 - 7 d3 - 7 D - 1 | | 0.7 | | |
| Gate Resistance | R _g | f = 1 MHz | 0.5 | 2.4 | 4.8 | Ω |
| Turn-On Delay Time | t _{d(on)} | | | 8 | 16 | |
| Rise Time | t _r | V_{DD} = 10 V, R_L = 2.2 Ω | | 17 | 26 | - |
| Turn-Off Delay Time | t _{d(off)} | $I_D\cong 4$ A, V_{GEN} = 4.5 V, R_g = 1 Ω | | 31 | 47 | 1 |
| Fall Time | t _f | | | 8 | 16 | - |
| Turn-On Delay Time | t _{d(on)} | | | 5 | 10 | ns |
| Rise Time | t _r | V_{DD} = 10 V, R_L = 2.2 Ω | | 13 | 20 | 1 |
| Turn-Off Delay Time | t _{d(off)} | $I_D\cong 4$ A, $V_{GEN}=5$ V, $R_g=1$ Ω | | 21 | 32 | - |
| Fall Time | t _f | | | 6 | 12 | - |
| Drain-Source Body Diode Characteristic | <u> </u> | | <u> </u> | <u> </u> | | |
| Continuous Source-Drain Diode Current | Is | T _C = 25 °C | | | 1.75 | |
| Pulse Diode Forward Current | I _{SM} | - | | | 20 | A |
| Body Diode Voltage | V _{SD} | I _S = 4 A, V _{GS} = 0 V | | 0.75 | 1.2 | V |
| Body Diode Reverse Recovery Time | t _{rr} | 2 00 | | 12 | 20 | ns |
| Body Diode Reverse Recovery Charge | Q _{rr} | | | 5 | 10 | nC |
| Reverse Recovery Fall Time | t _a | $I_F = 4$ A, $dI/dt = 100$ A/ μ s, $T_J = 25$ °C | | 7 | | |
| Reverse Recovery Rise Time | t _b | | — | 5 | | ns |

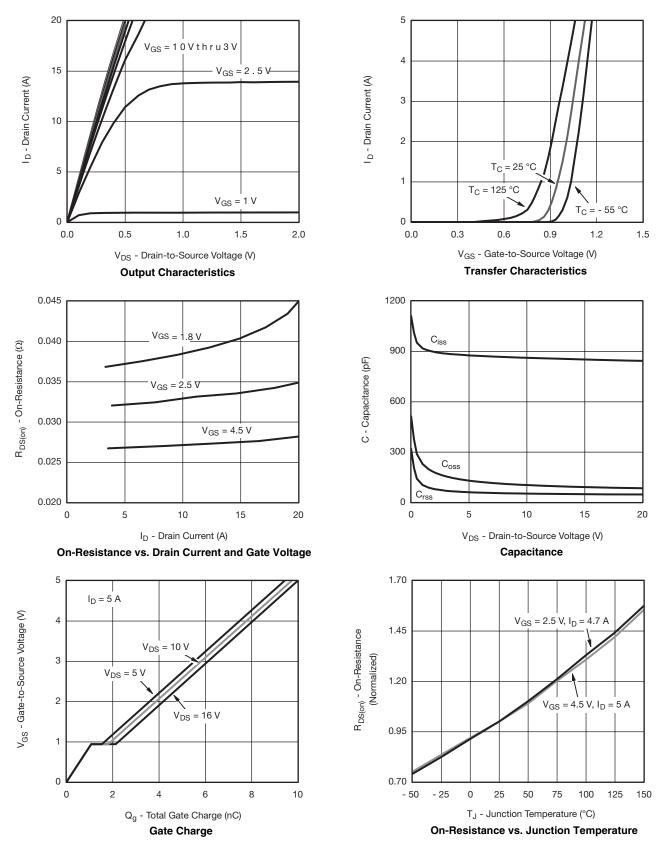
Notes:

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 % b. Guaranteed by design, not subject to production testing.



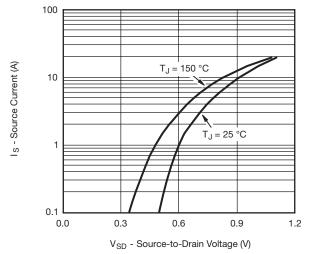
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



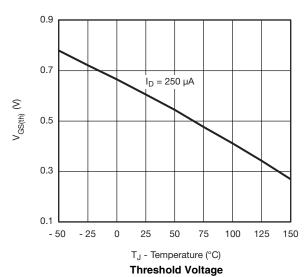
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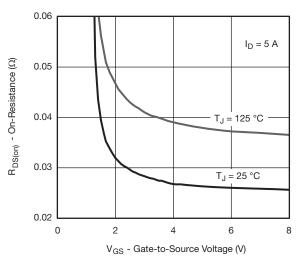


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Source-Drain Diode Forward Voltage

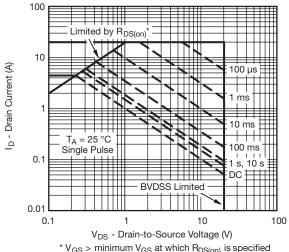




On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power (Junction-to-Ambient)

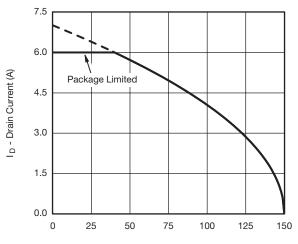


 * V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

Safe Operating Area, Junction-to-Ambient

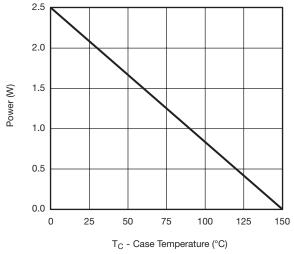


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

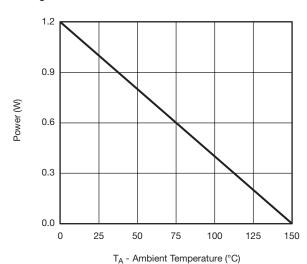


T_C - Case Temperature (°C)

Current Derating*







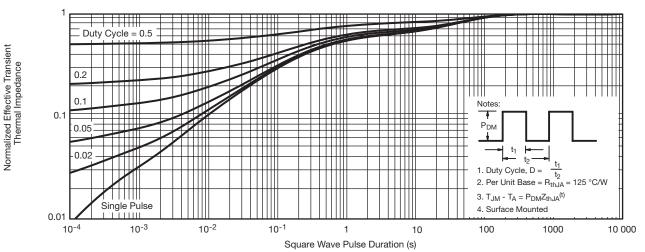
Power Derating, Junction-to-Ambient

^{*} The power dissipation P_D is based on $T_{J(max.)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

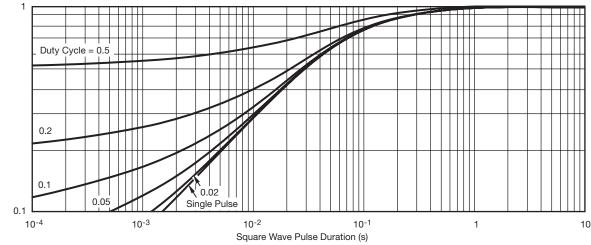
Normalized Effective Transient Thermal Impedance



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



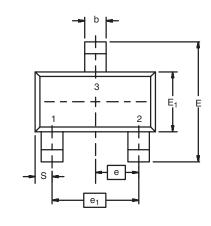
Normalized Thermal Transient Impedance, Junction-to-Ambient

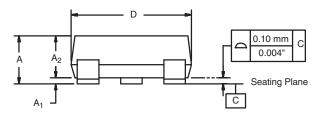


Normalized Thermal Transient Impedance, Junction-to-Foot



SOT-23 (TO-236): 3-LEAD







| Dim | MILLIM | IETERS | INCHES | | |
|----------------|----------|--------|------------|-------|--|
| | Min | Max | Min | Max | |
| Α | 0.89 | 1.12 | 0.035 | 0.044 | |
| A ₁ | 0.01 | 0.10 | 0.0004 | 0.004 | |
| A ₂ | 0.88 | 1.02 | 0.0346 | 0.040 | |
| b | 0.35 | 0.50 | 0.014 | 0.020 | |
| С | 0.085 | 0.18 | 0.003 | 0.007 | |
| D | 2.80 | 3.04 | 0.110 | 0.120 | |
| E | 2.10 | 2.64 | 0.083 | 0.104 | |
| E ₁ | 1.20 | 1.40 | 0.047 | 0.055 | |
| е | 0.95 | BSC | 0.0374 Ref | | |
| e ₁ | 1.90 | BSC | 0.074 | 8 Ref | |
| L | 0.40 | 0.60 | 0.016 | 0.024 | |
| L ₁ | 0.64 Ref | | 0.025 Ref | | |
| S | 0.50 Ref | | 0.020 |) Ref | |
| q | 3° | 8° | 3° | 8° | |

DWG: 5479



RECOMMENDED MINIMUM PADS FOR SOT-23



Recommended Minimum Pads Dimensions in Inches/(mm)



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